

# **HMC189MS8**

# GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 2 - 4 GHz INPUT

### **Typical Applications**

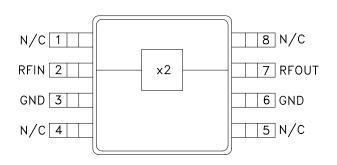
The HMC189MS8 is suitable for:

- Wireless Local Loop
- LMDS, VSAT, and Pt to Pt Radios
- UNII & HiperLAN
- Test Equipment

#### **Features**

Conversion Loss: 13 dB Fo, 3Fo, 4Fo Isolation: 33 dB Input Drive Level: +10 to +15 dBm

### Functional Diagram



### **General Description**

The HMC189MS8 is a miniature passive frequency doubler in a plastic 8-lead MSOP package. The suppression of undesired fundamental and higher order harmonics is 33 dB typical with respect to input signal levels. The doubler uses the same diode/balun technology used in Hittite MMIC mixers. The doubler is ideal for high volume applications where frequency doubling of a lower frequency is more economical than directly generating a higher frequency. The passive Schottky diode doubler technology contributes no measurable additive phase noise onto the multiplied signal.

# Electrical Specifications, $T_A = +25^{\circ}$ C, As a Function of Drive Level

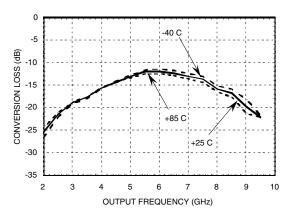
v01.0801

	Input = +10 dBm		Input = +13 dBm			Input = +15 dBm				
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, Input	2.5 - 3.5			2.5 - 3.75			2 - 4			GHz
Frequency Range, Output	5 - 7			5 - 7.5			4 - 8			GHz
Conversion Loss		13	17		13	15		13	17	dB
FO Isolation (with respect to input level)	29	32		30	33		31	34		dB
3FO Isolation (with respect to input level)	37	43		35	42		33	40		dB
4FO Isolation (with respect to input level)	32	40		33	40		31	40		dB

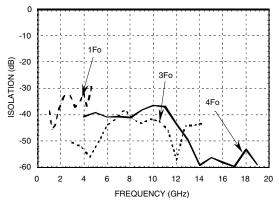


# GaAs MMIC SMT FREQUENCY DOUBLER, 2 - 4 GHz INPUT

#### Conversion Loss @ +13 dBm Drive Level

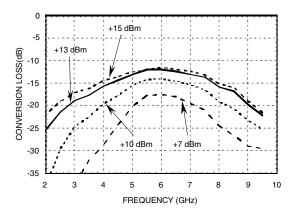


# Isolation\* @ +13 dBm Drive Level

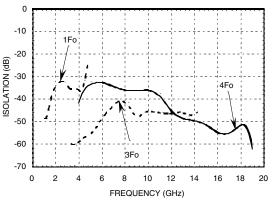


<sup>\*</sup> With respect to input level

#### Conversion Loss vs. Drive Level

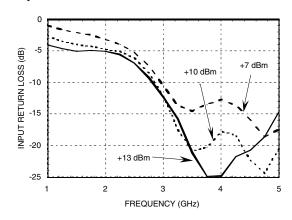


#### Isolation\* @ +10 dBm Drive Level

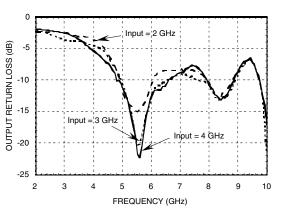


\* With respect to input level

### Input Return Loss vs. Drive Level



### Output Return Loss for Several Input Frequencies



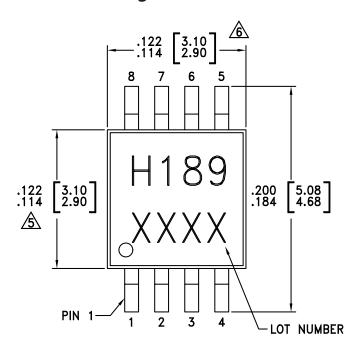


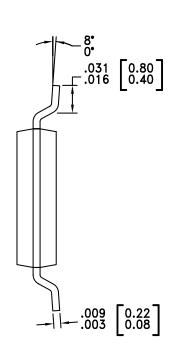
# GaAs MMIC SMT FREQUENCY DOUBLER, 2.0 - 4.0 GHz INPUT

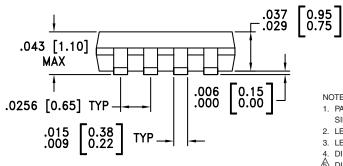
### Absolute Maximum Ratings

Input Drive	+27 dBm		
Storage Temperature	-65 to +150 °C		
Operating Temperature	-40 to +85 °C		

## **Outline Drawing**





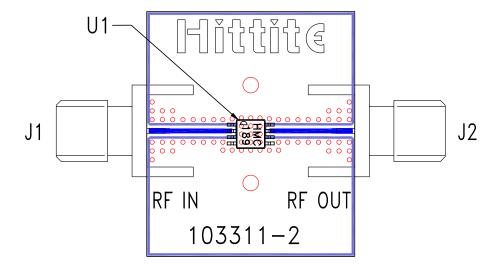


- PACKAGE BODY MATERIAL: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
- 2. LEADFRAME MATERIAL: COPPER ALLOY
- LEADFRAME PLATING: Sn/Pb SOLDER
- DIMENSIONS ARE IN INCHES [MILLIMETERS].
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15 mm PER SIDE.
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25 mm PER SIDE.
- ALL GROUND LEADS MUST BE SOLDERED TO PCB PF GROUND.



# GaAs MMIC SMT FREQUENCY DOUBLER, 2.0 - 4.0 GHz INPUT

#### **Evaluation PCB**



The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.

### List of Materials

Item	Description			
J1, J2	PC Mount SMA Connector			
U1	HMC189MS8 Doubler			
PCB*	103311 Eval Board			
*Circuit Board Material: Rogers 4350				